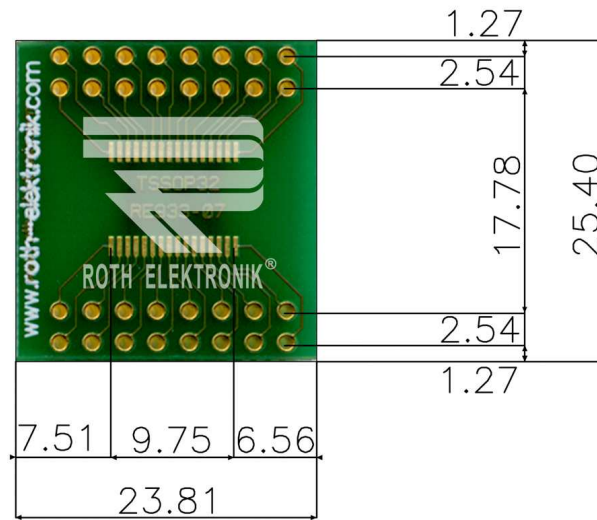




RE933-07

- Epoxy fibre-glass FR4 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au with solder stop mask
- Adaption circuit board for TSSOP 32
- Pitch: 0.65 mm (240 mil)
- Hole diameter 1.00 mm
- Size 23.81 x 25.40 mm

Module-No. Pitch mil Pin Size (mm)

RE933-07 0.650 mm 22.5 32 4.400 (173 mil)

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